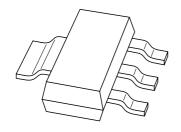
### **DISCRETE SEMICONDUCTORS**

## DATA SHEET



# PBSS5350Z50 V low V<sub>CEsat</sub> PNP transistor

Product specification Supersedes data of 2003 Jan 20 2003 May 13





## 50 V low V<sub>CEsat</sub> PNP transistor

PBSS5350Z

#### **FEATURES**

- · Low collector-emitter saturation voltage
- High collector current capability: I<sub>C</sub> and I<sub>CM</sub>
- High collector current gain (hFE) at high IC
- Higher efficiency leading to less heat generation
- Reduced PCB area requirements compared to DPAK.

#### **APPLICATIONS**

- · Power management
  - DC/DC converters
  - Supply line switching
  - Battery charger
  - Linear voltage regulation (LDO).
- Peripheral drivers
  - Driver in low supply voltage applications, e.g. lamps, LFDs
  - Inductive load driver, e.g. relays, buzzers, motors.

#### **DESCRIPTION**

PNP low  $V_{\text{CEsat}}$  transistor in a SOT223 plastic package. NPN complement: PBSS4350Z.

#### **MARKING**

TYPE NUMBER	MARKING CODE
PBSS5350Z	PB5350

#### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	MAX.	UNIT
V <sub>CEO</sub>	collector-emitter voltage	-50	V
Ic	collector current (DC)	-3	Α
I <sub>CM</sub>	peak collector current	-5	Α
R <sub>CEsat</sub>	equivalent on-resistance	<150	mΩ

#### **PINNING**

2

PIN	DESCRIPTION
1	base
2	collector
3	emitter
4	collector

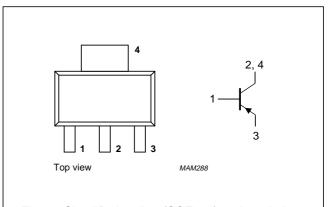


Fig.1 Simplified outline (SOT223) and symbol.

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#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{CBO}$	collector-base voltage	open emitter	_	-60	V
$V_{CEO}$	collector-emitter voltage	open base	_	-50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	_	-6	V
I <sub>C</sub>	collector current (DC)		_	-3	Α
I <sub>CM</sub>	peak collector current		_	-5	Α
I <sub>BM</sub>	peak base current		_	-1	Α
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; notes 1 and 3	_	1.35	W
		T <sub>amb</sub> ≤ 25 °C; notes 2 and 3	_	2	W
T <sub>stg</sub>	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C

#### **Notes**

- 1. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm<sup>2</sup>.
- 2. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 6 cm<sup>2</sup>.
- 3. For other mounting conditions see "Thermal considerations for SOT223 in the General Part of associated Handbook".

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	in free air; notes 1 and 3	92	K/W
		in free air; notes 2 and 3	62.5	K/W

#### **Notes**

- 1. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 1 cm.
- 2. Device mounted on a printed-circuit board; single sided copper; tinplated; mounting pad for collector 6 cm<sup>2</sup>.
- 3. For other mounting conditions see "Thermal considerations for SOT223 in the General Part of associated Handbook".

## 50 V low $V_{\text{CEsat}}$ PNP transistor

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#### **CHARACTERISTICS**

 $T_{amb}$  = 25 °C unless otherwise specified.

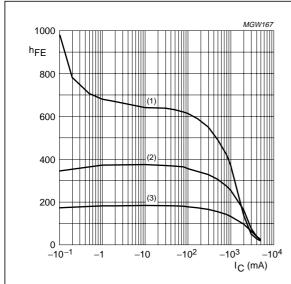
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = -50 \text{ V}; I_E = 0$	_	_	-100	nA
		V <sub>CB</sub> = -50 V; I <sub>E</sub> = 0; T <sub>j</sub> = 150 °C	_	_	-50	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = -5 \text{ V}; I_C = 0$	_	_	-100	nA
h <sub>FE</sub>	DC current gain	V <sub>CE</sub> = −2 V;				
		$I_{C} = -500 \text{ mA}$	200	_	_	
		$I_{C} = -1 \text{ A}$ ; note 1	200	_	_	
		$I_{C} = -2 \text{ A}$ ; note 1	100	_	_	
V <sub>CEsat</sub>	collector-emitter saturation	$I_C = -500 \text{ mA}; I_B = -50 \text{ mA}$	_	_	-100	mV
	voltage	$I_C = -1 \text{ A}; I_B = -50 \text{ mA}$	_	_	-180	mV
		$I_C = -2 \text{ A}$ ; $I_B = -200 \text{ mA}$ ; note 1	_	_	-300	mV
R <sub>CEsat</sub>	equivalent on-resistance	$I_C = -2 \text{ A}$ ; $I_B = -200 \text{ mA}$ ; note 1	_	120	<150	mΩ
V <sub>BEsat</sub>	base-emitter saturation voltage	$I_C = -2 \text{ A}; I_B = -200 \text{ mA}; \text{ note 1}$	_	_	-1.2	V
V <sub>BEon</sub>	base-emitter turn-on voltage	$V_{CE} = -2 \text{ V}; I_{C} = -1 \text{ A}; \text{ note 1}$	_	_	-1.1	V
f <sub>T</sub>	transition frequency	$I_C = -100 \text{ mA}; V_{CE} = -5 \text{ V};$ f = 100 MHz	100	_	_	MHz
C <sub>c</sub>	collector capacitance	$V_{CB} = -10 \text{ V}; I_E = I_e = 0; f = 1 \text{ MHz}$	_	_	40	pF

#### Note

1. Pulse test:  $t_p \le 300~\mu s;~\delta \le 0.02.$ 

## 50 V low V<sub>CEsat</sub> PNP transistor

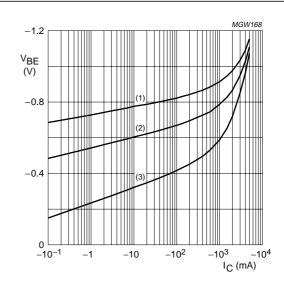
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 $V_{CE} = -2 V$ .

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55$  °C.

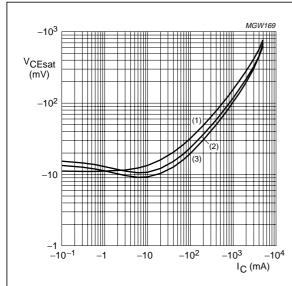
Fig.2 DC current gain as a function of collector current; typical values.



 $V_{CE} = -2 V$ .

- (1)  $T_{amb} = -55 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = 150 \, ^{\circ}C$ .

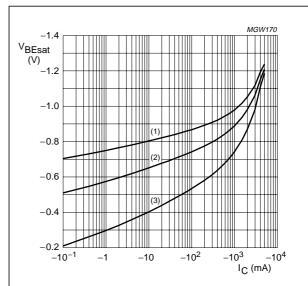
Fig.3 Base-emitter voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 10.$ 

- (1)  $T_{amb} = 150 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = -55 \, ^{\circ}C$ .

Fig.4 Collector-emitter saturation voltage as a function of collector current; typical values.



 $I_{\rm C}/I_{\rm B} = 10.$ 

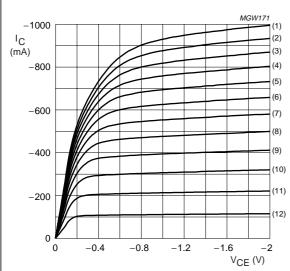
- (1)  $T_{amb} = -55 \, ^{\circ}C$ .
- (2)  $T_{amb} = 25 \, ^{\circ}C$ .
- (3)  $T_{amb} = 150 \, ^{\circ}C$ .

Fig.5 Base-emitter saturation voltage as a function of collector current; typical values.

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 $T_{amb} = 25 \, ^{\circ}C.$ 

(1)  $I_B = -3.96 \text{ mA}.$ 

(5)  $I_B = -2.64 \text{ mA}.$ 

(9)  $I_B = -1.32 \text{ mA}.$ 

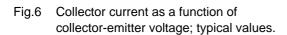
(2)  $I_B = -3.63 \text{ mA}.$ 

(6)  $I_B = -2.31 \text{ mA}.$ (7)  $I_B = -1.98 \text{ mA}.$  (10)  $I_B = -0.99$  mA. (11)  $I_B = -0.66$  mA.

(3)  $I_B = -3.30 \text{ mA}.$ (4)  $I_B = -2.97 \text{ mA}.$ 

(8)  $I_B = -1.65 \text{ mA}.$ 

(12)  $I_B = -0.33 \text{ mA}.$ 



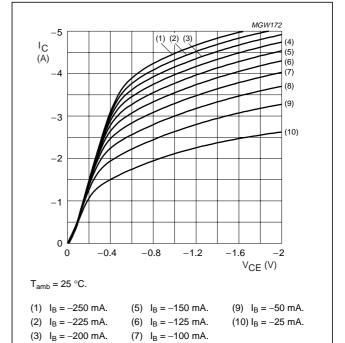


Fig.7 Collector current as a function of

(8)  $I_B = -75 \text{ mA}.$ 

collector-emitter voltage; typical values.

(4)  $I_B = -175 \text{ mA}.$ 

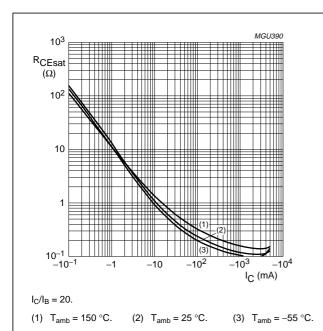


Fig.8 Collector-emitter equivalent on-resistance as a function of collector current; typical values.

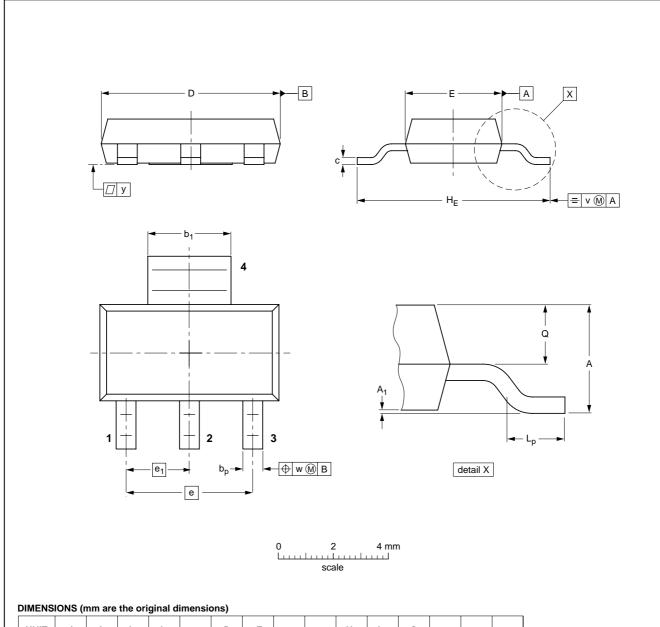
## 50 V low $V_{CEsat}$ PNP transistor

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#### **PACKAGE OUTLINE**

Plastic surface mounted package; collector pad for good heat transfer; 4 leads

**SOT223** 



UNI	А	A <sub>1</sub>	bp	b <sub>1</sub>	С	D	E	е	e <sub>1</sub>	HE	Lp	Q	٧	w	у
mm	1.8 1.5	0.10 0.01	0.80 0.60	3.1 2.9	0.32 0.22	6.7 6.3	3.7 3.3	4.6	2.3	7.3 6.7	1.1 0.7	0.95 0.85	0.2	0.1	0.1

OUTLINE		EUROPEAN	ISSUE DATE			
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT223			SC-73			<del>-97-02-28</del> 99-09-13

## 50 V low V<sub>CEsat</sub> PNP transistor

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NOTES

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NOTES

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